

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7738578

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LUKAS CARULLO	02/21/2019
PATRICK BROSE	02/21/2019
KUN BAO	02/22/2019
ANUBHAV BHATIA	02/21/2019
RASHMI SHETTY B	02/21/2019
LEONARD BRZEZINSKI	02/21/2019
LAUREN MCMULLEN	02/21/2019
HARPREET SINGH	02/21/2019
KARTHIK MOHAN MOKASHI	02/21/2019
SIMON LEE	02/23/2019
RECEIVING PARTY DATA	
Name:	SAP SE
Street Address:	DIETMAR-HOPP-ALLEE 16
City:	WALLDORF
State/Country:	GERMANY
Postal Code:	69190
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	18096080
CORRESPONDENCE DATA	
Fax Number:	(203)972-7627
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2039720081
Email:	Colabella@bmtpatent.com, murray@bmtpatent.com
Correspondent Name:	BUCKLEY, MASCHOFF & TALWALKAR LLC
Address Line 1:	50 LOCUST AVE # 9
Address Line 4:	NEW CANAAN, CONNECTICUT 06840
ATTORNEY DOCKET NUMBER:	190119US02 (S23.268C)

NAME OF SUBMITTER:	NICHOLAS M. STABLER
SIGNATURE:	/Nicholas M. Stabler/
DATE SIGNED:	01/12/2023
Total Attachments: 10 source=190119US01_S23268_Assignment#page1.tif source=190119US01_S23268_Assignment#page2.tif source=190119US01_S23268_Assignment#page3.tif source=190119US01_S23268_Assignment#page4.tif source=190119US01_S23268_Assignment#page5.tif source=190119US01_S23268_Assignment#page6.tif source=190119US01_S23268_Assignment#page7.tif source=190119US01_S23268_Assignment#page8.tif source=190119US01_S23268_Assignment#page9.tif source=190119US01_S23268_Assignment#page10.tif	

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Lukas Carullo**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

FAILURE MODE ANALYTICS

which is found in the:

US patent application filed on: February 25, 2019

under Application No. 16/284,369

I authorize and request the attorneys of record or the attorney filing the application to insert into this assignment the filing date and serial number of the application when known. This assignment includes the foregoing patent application or patent, as well as continuations and divisionals of said application, all legal equivalents in any country, and all patents issuing from such legal equivalents; all patents, utility models, and design registrations granted by any jurisdiction for any of said inventions and improvements; and the right to claim priority based on the filing date of the foregoing patent application or patent under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes. I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, and design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements. I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into that would conflict with this assignment. I hereby state and agree that no assignment, sale, agreement, or encumbrance has been or will be made or entered into that would conflict with this assignment. I further agree for myself and my heirs, legal representatives, and assigns to provide to the Assignee promptly upon its request and at its expense all pertinent facts and documents relating to any of said inventions and improvements or said patents and legal equivalents as may be known and accessible to me and to testify as to the same in any interference, litigation, or proceeding relating thereto; and I agree promptly to perform such lawful acts and to sign such further applications, assignments, statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Inventor's Signature:

DocuSigned by:
Lukas Carullo

2/21/2019

Lukas Carullo

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Patrick Brose**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

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Inventor's Signature:

DocuSigned by:
Patrick Brose

2/21/2019

Patrick Brose

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Kun Bao**,

hereby assign to

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Inventor's Signature:

DocuSigned by:

Kun Bao

2/22/2019

Kun Bao

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Anubhav Bhatia**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Anubhav Bhatia

2/21/2019

Anubhav Bhatia

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Rashmi Shetty B.**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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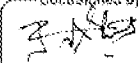
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Inventor's Signature:

DocuSigned by:


2/21/2019

Rashmi Shetty B

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Leonard Brzezinski**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Leonard R Brzezinski

Leonard Brzezinski

2/21/2019

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Lauren McMullen**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Lauren McMullen

2/21/2019

Lauren McMullen

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, Harpreet Singh,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf,
Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the
world in the inventions and improvements in a patent document entitled:

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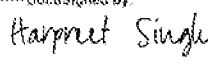
which is found in the:

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Inventor's Signature:

DocuSigned by:

Harpreet Singh

2/21/2019

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Karthik Mohan Mokashi**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Karthik Mohan Mokashi
Karthik Mohan Mokashi

2/21/2019

Attorney Dkt. No. S23.268 / 190119US01

ASSIGNMENT

For valuable consideration, I, **Simon Lee**,
hereby assign to

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and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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DocuSigned by:
Simon Lee

2/23/2019

Simon Lee